

VISION PLACEMENT

Since 1980



VISION PLACEMENT - 20000DA⁺



High Productivity

- 30,000 UPH (Based on Dry Run)



Supreme Vision Inspection

- 3D Vision Inspection
- 6 Side View
- 12 Mega pixel camera



High Density Substrate Capability

- Max. 100mm x 300mm Substrate Size



Small Package Capability

- Min. 2mm x 2mm (3,000 unit/ strip)



Semiconductor

VISION PLACEMENT 30000L / 20000DA⁺

Enhanced Machine Features

■ Individual Operation Dual Chuck Sawing Process

- Two Separate Cutting Chuck Tables
- Remarkable Reduction of Sawing Delay Time & Unloading Time

■ Casting Body for High Durability & Minimum Vibration

■ Small Unit Handling

- High Stability for Pick-up and Placement
- High Precise & Accurate Handling for Small Packages

■ Supreme Vision Inspection

- Variety of Inspection Items with High Performance Vision System
- Capable of 3D Vision Inspection (Optional)



VISION PLACEMENT - 30000L



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Application	UPH	30,000	30,000
Strip Size	mm	300 x 100	270 x 146 / 300 x 100
System Performance	MTBA	2 hours	
	MTBF	168 hours	
	MTTA	3 minutes	
	MTTR	30 minutes	